



## Hyper- and Multi-Spectral Imaging

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Deadline for manuscript  
submissions:

**closed (30 June 2018)**

### Message from the Guest Editor

Dear Colleagues,

Spectral Imaging (SI) combines the advantages of both imaging and spectroscopy (high spatial and spectral resolution) in a single instrument. In SI, light intensity is recorded as a function of both wavelength and location. The output is a three-dimensional data structure known as spectral cube, with each pixel representing the spectrum of the scene at that point. Most recent developments include snapshot or single exposure SI cameras, which capture the images of the spectral cube simultaneously or, alternatively, spectral cube streams at nearly video rates. Dynamic SI implies that light intensity can now be recorded as a function of time, wavelength, polarization, two or more spatial locations, etc.

We invite investigators to contribute original research articles, as well as review articles, that will stimulate the continuing efforts in the field of SI.

Prof. Costas Balas

*Guest Editor*

Keywords: Hyper-Spectral Imaging; Multi-Spectral Imaging; Snap-Shot Spectral Imaging; Spectral Cube Data Analysis/Processing; Biomedicine; Remote sensing; Microscopy; Non-Destructive Testing





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## Message from the Editor-in-Chief

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